

BRCS100N10SDP

Rev.A Jun.-2024

/ Descriptions

TO-252 N
N-CHANNEL MOSFET in a TO-252 Plastic Package.

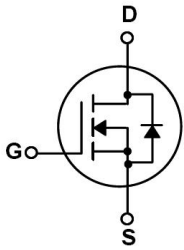
/ Features

$V_{DS}=100V$ $I_D=60A$
 $R_{DS(ON)}@10V$ 10m Ω (Typ.9m Ω)
 $R_{DS(ON)}@4.5V$ 15m Ω (Typ.11m Ω)
HF Product.

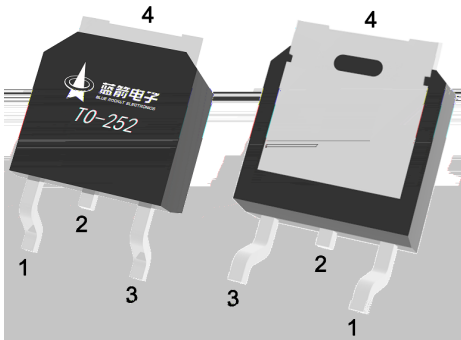
/ Applications

High Frequency Switching and Synchronous Rectification.

/ Equivalent Circuit



/ Pinning



PIN1 G PIN 2 D PIN 3 S PIN 4 D

/ Marking

See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	100	V	
Drain Current - Continuous	I_D	60	A	
Drain Current – Pulsed	I_{DM}	139	A	
Gate-Source Voltage	V_{GS}	± 20	V	
Power Dissipation	$P_D(T_c=25)$	73	W	
Single Pulse Avalanche Energy(L=0.5mH)	E_{AS}	1200	mJ	
Avalanche Current(L=0.5mH)	I_{AS}	25	A	
Junction and Storage Temperature Range	T_j, T_{stg}	-55 to 150		
Thermal resistance, junction - ambient	t 10s	$R_{\theta JA}$	20	/ W
	Steady-State		50	
Thermal resistance, junction - case	Steady-State	$R_{\theta JC}$	1.71	

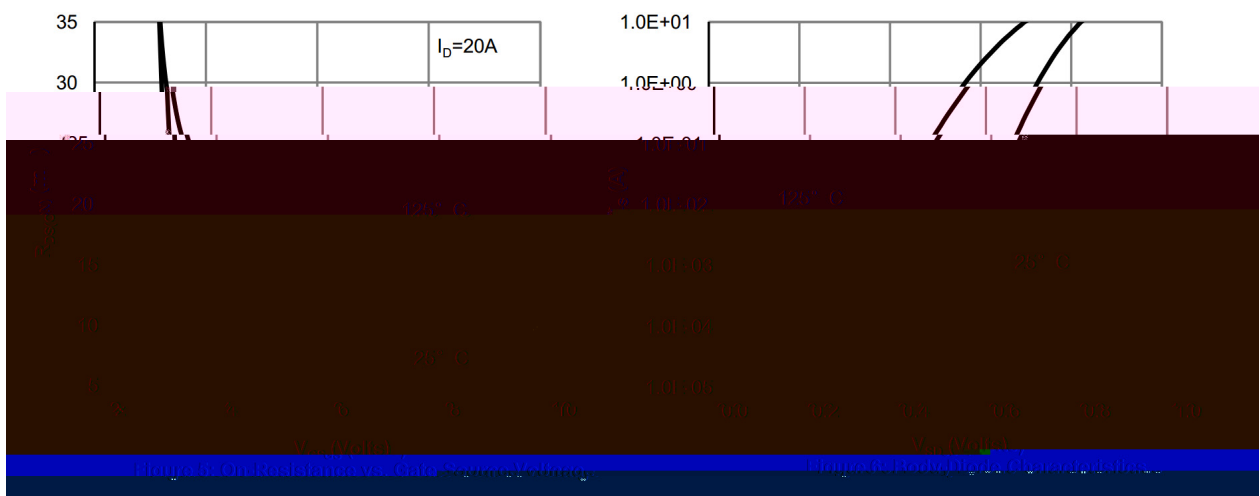
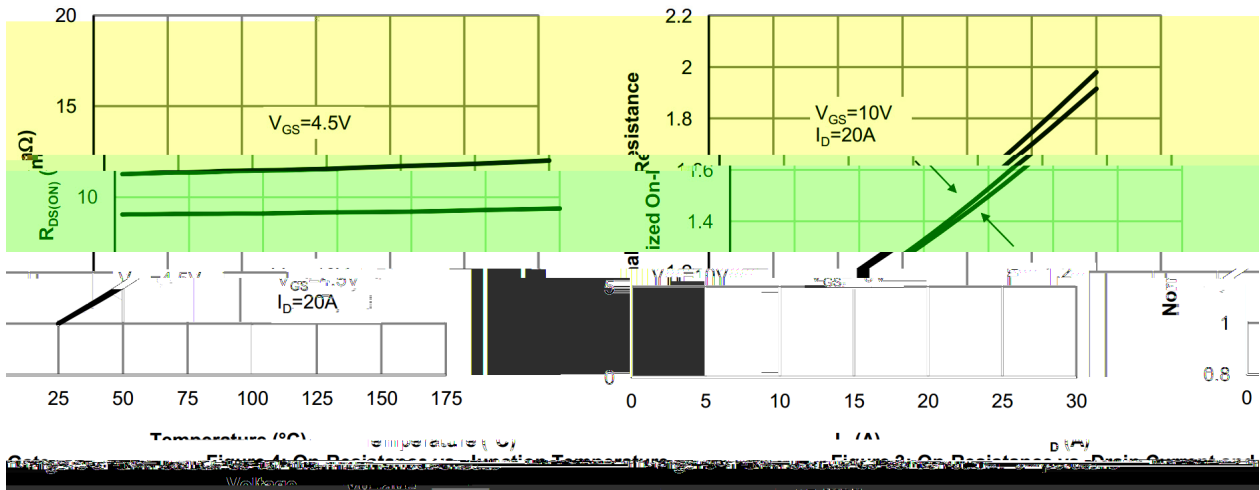
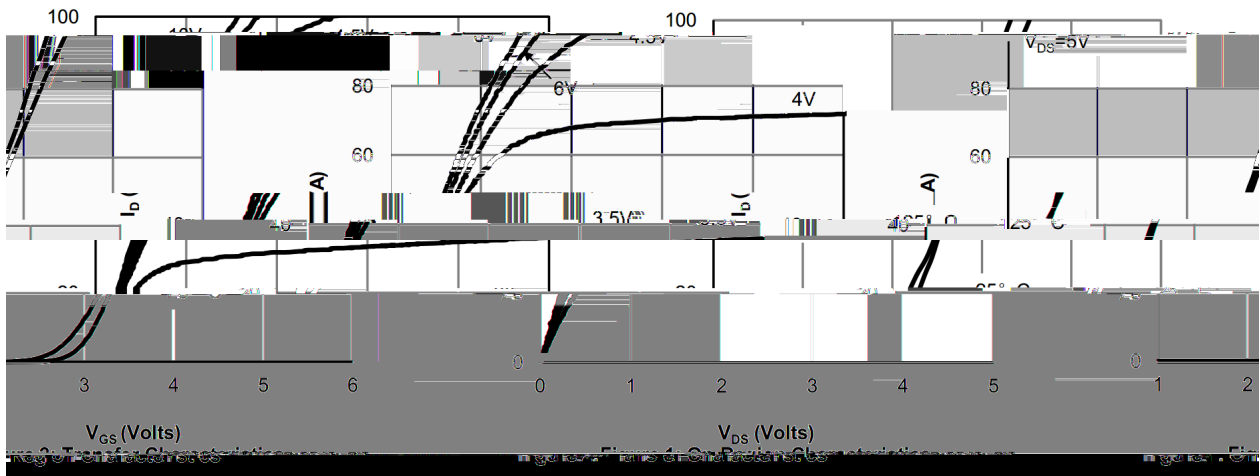
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$ $I_D=250\mu A$	100	108		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=100V$ $V_{GS}=0V$			1.0	μA
Gate-Body Leakage Current Forward	I_{GSS}	$V_{GS}=\pm 20V$ $V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	1	1.8	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=20A$		9	10	m Ω
	$R_{DS(on)}$	$V_{GS}=4.5V$ $I_D=10A$		11	15	m Ω
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V$ $I_S=1A$			1.2	V
Gate resistance	R_g	$V_{GS}=0V$ $V_{DS}=0V,$ $f=1MHz$		1.3		Ω
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1.0MHz$		2200		pF
Output Capacitance	C_{oss}			800		
Reverse Transfer Capacitance	C_{rss}			70		
Total Gate Charge	$Q_{g(10V)}$	$V_{GS}=10V,$ $V_{DS}=50V,$ $I_D=20A$		26		nC
Total Gate Charge	$Q_{g(4.5V)}$			12.9		
Gate Source Charge	Q_{gs}			6.5		
Gate Drain Charge	Q_{gd}			4.2		

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10V$ $V_{DS}=50V$ $R_L=2.5\Omega$ $R_{GEN}=3\Omega$		8.7		ns
Turn-On Rise Time	t_r			3.5		
Turn-Off Delay Time	$t_{d(off)}$			25		
Turn-Off Fall Time	t_f			4.2		

/ Electrical Characteristic Curve



/ Electrical Characteristic Curve

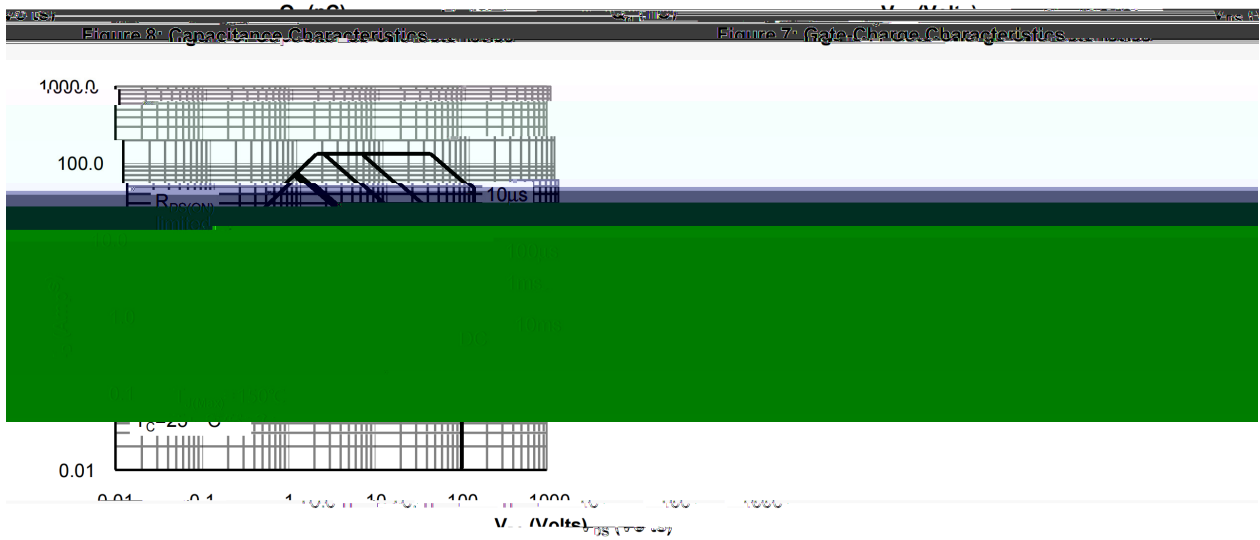
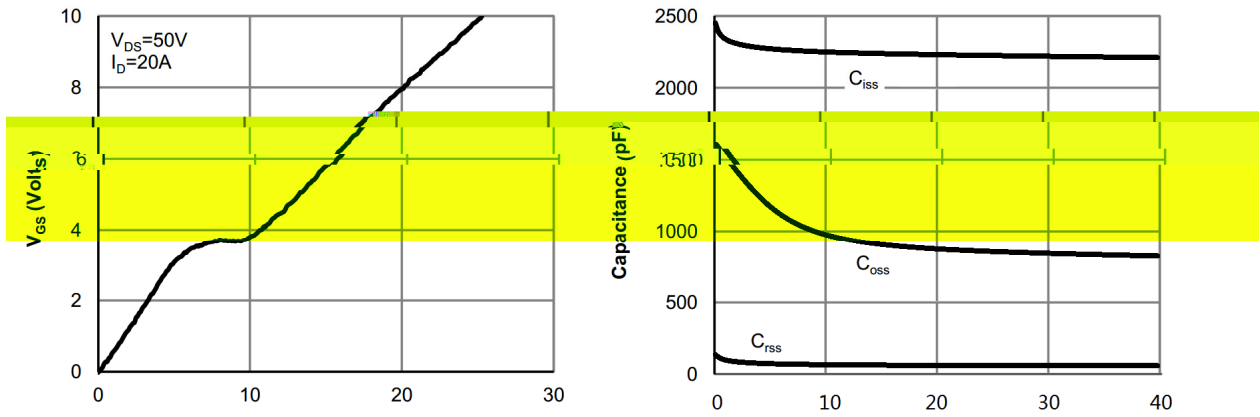


Figure 9: Maximum Forward Biased Safe Operating Area

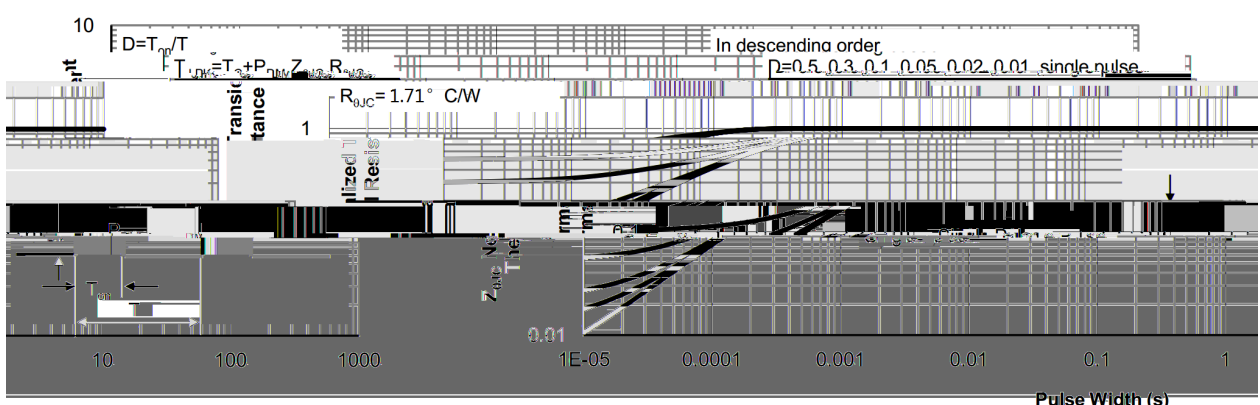
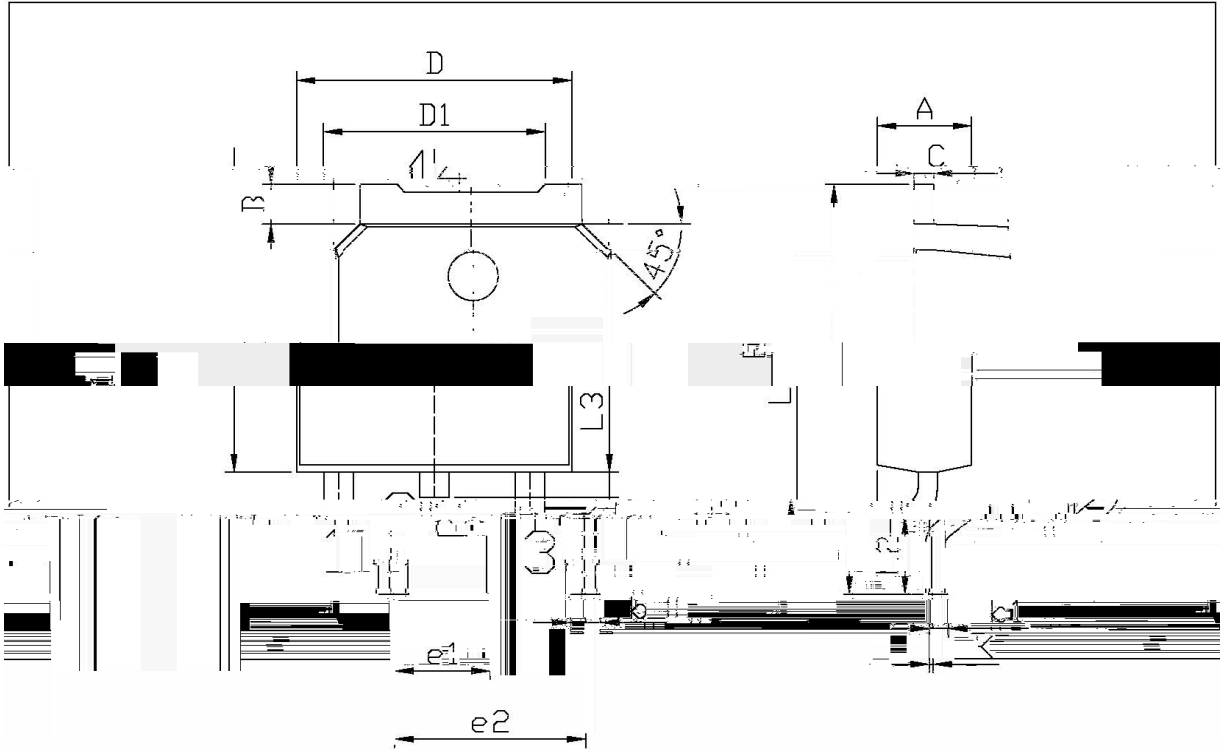


Figure 10: Normalized Maximum Transient Thermal Impedance

/ Package Dimensions

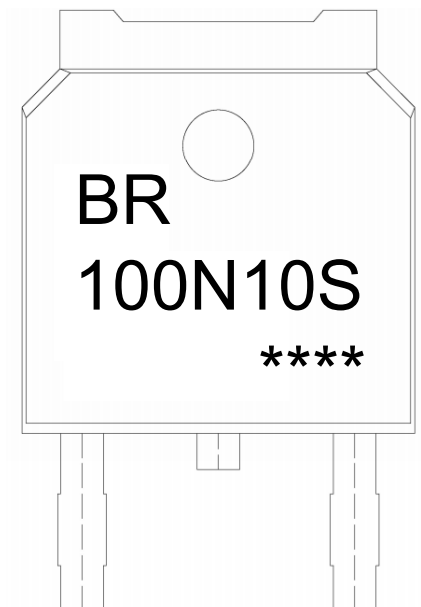


单位: mm

Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
6.25	6.25	6.25	A	2.20	2.40
2.34	2.34	2.34	B	0.95	1.25
1.25	1.25	1.25	e1	0.70	0.80
9.85	10.35	10.35	e2	0.45	0.55
1.25	1.25	1.25	L3	1.70	2.00
0.90	0.90	0.90	D1	6.45	6.75
0.10	0.10	0.10	D	6.50	6.80

TO-252

/ Marking Instructions



BR

100N10S

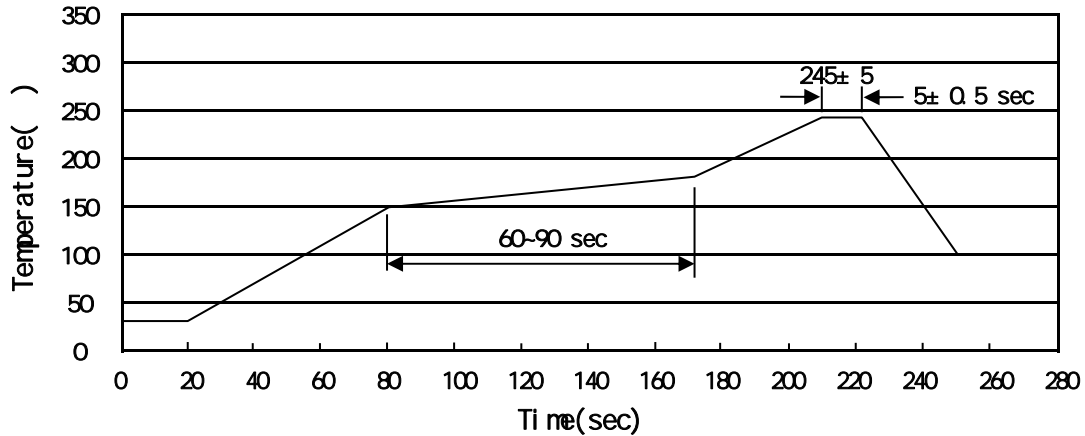
Note:

BR: Company Code

100N10S: Product Type Code

****: Lot No. Code, code change with Lot No

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Note:

- | | | | | | |
|---|-------|-----|-----------|--------|---|
| 1 | 150 | 180 | 60 | 90sec; | 1.Preheating:150~180 , Time:60~90sec. |
| 2 | 245±5 | | 5±0.5sec; | | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
TO-252	2,500	2	5,000	6	30,000	13 ×16	360×360×50	380×335×366

/ TUBE

Package Type	Units					Dimension (unit mm ³)		
	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Tube	Inner Box	Outer Box
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	575×290×180

/ Notices